TOSHIBA Photocoupler GaAs Ired & Photo-Transistor

TLP626, TLP626-2, TLP626-4

Programmable Controllers AC / DC-Input Module Telecommunication

The TOSHIBA TLP626, -2 and -4 consist of gallium arsenide infrared emitting diodes connected in inverse parallel, optically coupled to a photo–transistor.

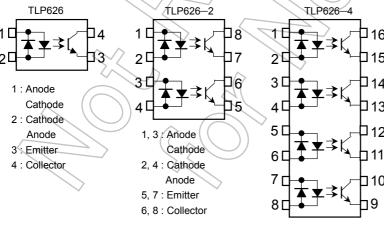
The TLP626–2 offers two isolated channels in an eight lead plastic DIP, while the TLP626–4 provides four isolated channels in a sixteen plastic DIP

- Collector-emitter voltage: 55V (min)
- Current transfer ratio

| | Curre | (7) | | |
|----------------|--|--|---|----------------|
| Classification | Ta = 25°C | | Ta = -25~75°C | Marking of |
| | $I_F = \pm 1 \text{mA}$ $V_{CE} = 0.5 \text{V}$ | $I_F = \pm 0.5 \text{mA}$ $V_{CE} = 1.5 \text{V}$ | I _F = ±1mA V _{CE} = 0.5V | Classification |
| Rank BV | 200% | 100% | 100% | BV |
| Standard | 100% | 50% | 50% | BV, blank |

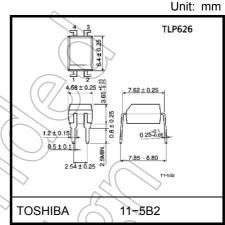
- Isolation voltage: 5000V_{rms} (min)
- UL recognized: UL1577, file no.E67349
- BSI approved: BS EN60065: 2002 certificate no.7426
 BS EN60950-1: 2002 certificate no.7427
- Note: Application type name for certification test, please use standard product type name, i.e. TLP626(BV): TLP626

Pin Configuration (top view)

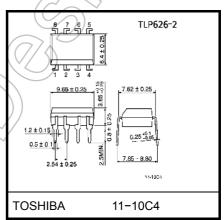


1, 3, 5, 7 : Anode, Cathode 2, 4, 6, 8 : Cathode, Anode 9, 11, 13, 15 : Emitter

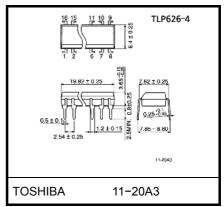
10, 12, 14, 16 : Collector



Weight: 0,26 g (typ.)



Weight: 0.54 g (typ.)



Weight: 1.1 g (typ.)

Start of commercial production 1984/04



Absolute Maximum Ratings (Ta = 25°C)

| | Characteristic | | Rati | Rating | | |
|----------------------------|--|----------------------------|------------------|----------------------|---------|--|
| | Characteristic | Symbol | TLP626 | TLP626-2 TLP626-4 | Unit | |
| | Forward current | lF | 60 | 50 | mA | |
| | Forward current derating | ΔI _F / °C | –0.7 (Ta ≥ 39°C) | –0.5 (Ta ≥ 39°C) | mA / °C | |
| Ω | Pulse forward current | | 1 (100µs pul | se,100pps) | Α | |
| LED | Power dissipation (1 circuit) | PD | 100 | 70 | mW | |
| | Power dissipation derating (Ta ≥ 25°C, 1 circuit) | ΔP _D / °C | _1.0 | -0.7 | mW / °C | |
| | Junction temperature | Tj | 12 | 5 | °C | |
| | Collector-emitter voltage | oltage V _{CEO} 55 | | V | | |
| | Emitter–collector voltage | | 7 | | V | |
| ctor | Collector current | I _C | 50 | | mA | |
| Detector | Collector power dissipation (1 circuit) | PC | 150 | 100 | mW | |
| | Collector power dissipation derating (Ta ≥ 25°C, 1 circuit) | ΔP _C /°C | _1.5 < | 1.0 | mW / °C | |
| | Junction temperature | Tj | 12 | 5 | °C | |
| Sto | rage temperature range | T _{stg} | -55 to 125 | | °C | |
| Оре | erating temperature range | Popr | -55 to 100 | | °C | |
| Lead soldering temperature | | T _{sol} | 260 (10s) | | °C | |
| Tot | al package power dissipation (1 circuit) | P _T | 250 | 150 | mW | |
| Tot | al package power dissipation derating (Ta ≥ 25°C, 1 circuit) | ΔP _T /°C | -2.5 | -1.5 | mW / °C | |
| Isol | ation voltage (Note 1) | BVS | 5000 (AC, 1minu | ute, R.H.≤60%) | Vrms | |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal: LED side pins shorted together, and detector side pins shorted together.

Recommended Operating Conditions

| Characteristic | Symbol | Min | Тур. | Max | Unit |
|-----------------------|---------------------|-----|------|-----|------|
| Supply voltage | V _C C | _ | 5 | 24 | V |
| Forward current | I _{F(RMS)} | - | 1.6 | 20 | mA |
| Collector current | \rightarrow Ic | _ | 1 | 10 | mA |
| Operating temperature | T _{opr} | -25 | _ | 75 | °C |

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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Individual Electrical Characteristics (Ta = 25°C)

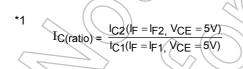
| | Characteristic | Symbol | Test Condition | Min | Тур. | Max | Unit |
|----------|-------------------------------------|----------------------|----------------------------------|------|----------|-----|------|
| | Forward voltage | V _F | I _F = ±10mA | 1.0 | 1.15 | 1.3 | V |
| LED | Reverse current | l _F | V _F = ±0.7V | _ | 2.5 | 20 | μΑ |
| | Capacitance | C _T | V = 0, f = 1MHz | _ < | 60 | - | pF |
| | Collector-emitter breakdown voltage | V _{(BR)CEO} | I _C = 0.5mA | 55 | | | V |
| ō | Emitter–collector breakdown voltage | V _{(BR)ECO} | I _E = 0.1mA | 7 | |)>- | V |
| Detector | Collector dark current | lana | V _{CE} = 24V | 6 | 10 | 100 | nA |
| ă | Collector dark current | ICEO | V _{CE} = 24V, Ta = 85°C | / FX | <u>)</u> | 50 | μΑ |
| | Capacitance collector to emitter | C _{CE} | V=0, f=1MHz | 1 | 12 | _ | pF |

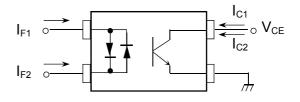
Coupled Electrical Characteristics (Ta = 25°C)

| | | () | | | \sim | |
|--------------------------------------|---------------------------------------|---|------------|----------|-----------------|------|
| Characteristic | Symbol | Test Condition | Min | Тур. | Max | Unit |
| Current transfer ratio | I _C / I _F | $I_F = \pm 1$ mA, $V_{CE} = 0.5$ V rank BV | 100 | 7 | 1200 1200 | % |
| Low input CTR | I _C / I _F (low) | $I_F = \pm 0.5$ mA, $V_{CE} = 1.5$ V rank BV | 50 | 2 | ⁷ – | % |
| Collector–emitter saturation voltage | V _{CE} (sat) | $I_C = 0.5$ mA, $I_F = \pm 1$ mA $I_C = 1$ mA, $I_F = \pm 1$ mA rank BV | \ <u>-</u> | 0.2 — | 0.4 — 0.4 | ٧ |
| Off-state collector current | I _C (off) | V _F = ±0.7V, V _{CE} = 24V | //- | 1 | 10 | μA |
| CTR symmetry *1 | I _C (ratio) | $I_{C}(I_{F} = -1mA) / I_{C}(I_{F} = 1mA)$ | 0.5 | _ | 2 | _ |

Coupled Electrical Characteristics (Ta = $-25 \sim 75^{\circ}$ C)

| Characteristic | Symbol | Test Condition | Min | Тур. | Max | Unit |
|------------------------|---------------------------------------|--|-----|------|-----|------|
| Current transfer ratio | → 10/1= < | $I_F = 1 \text{mA}, V_{CE} = 0.5 \text{V}$ | 50 | - | ı | % |
| Current transfer ratio | I _C /I _F | rank BV | 100 | 1 | - | 70 |
| Low input CTP | I _C / I _F (low) | I _F = 0.5mA, V _{CE} = 1.5V | 1 | 50 | 1 | % |
| Low input CTR | IC / IF(IOM) | rank BV | _ | 100 | _ | /0 |







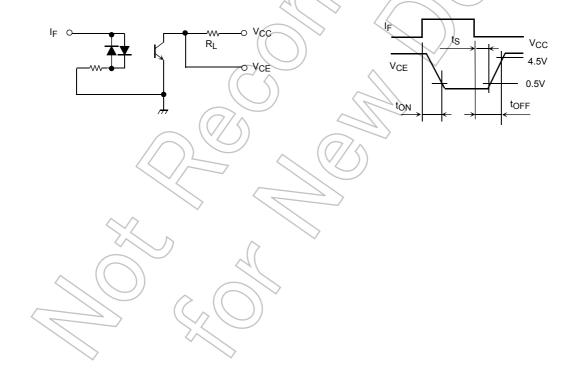
Isolation Characteristics (Ta = 25°C)

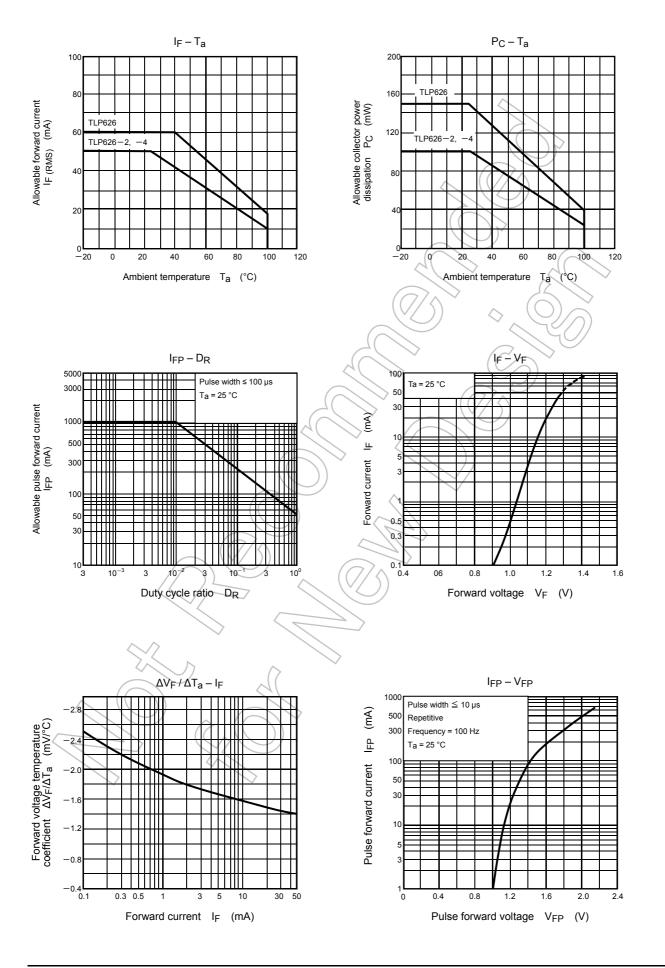
| Characteristic | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-----------------------------|----------------|------------------------------|--------------------|------------------|-----|------|
| Capacitance input to output | CS | V _S = 0, f = 1MHz | _ | 0.8 | _ | pF |
| Isolation resistance | R _S | V _S = 500V | 5×10 ¹⁰ | 10 ¹⁴ | _ | Ω |
| | | AC, 1 minute | 5000 | /- | _ | Vrma |
| Isolation voltage | BV_S | AC, 1 second, in oil | _ | 10000 | _ | Vrms |
| | | DC, 1 minute, in oil | _ | 10000 |)/_ | Vdc |

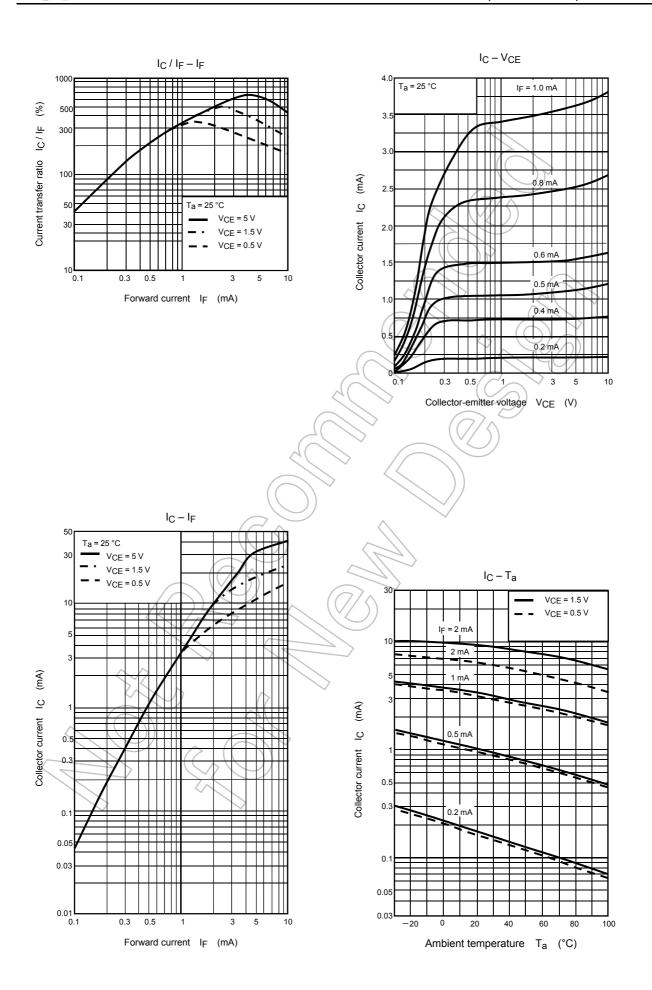
Switching Characteristics (Ta = 25°C)

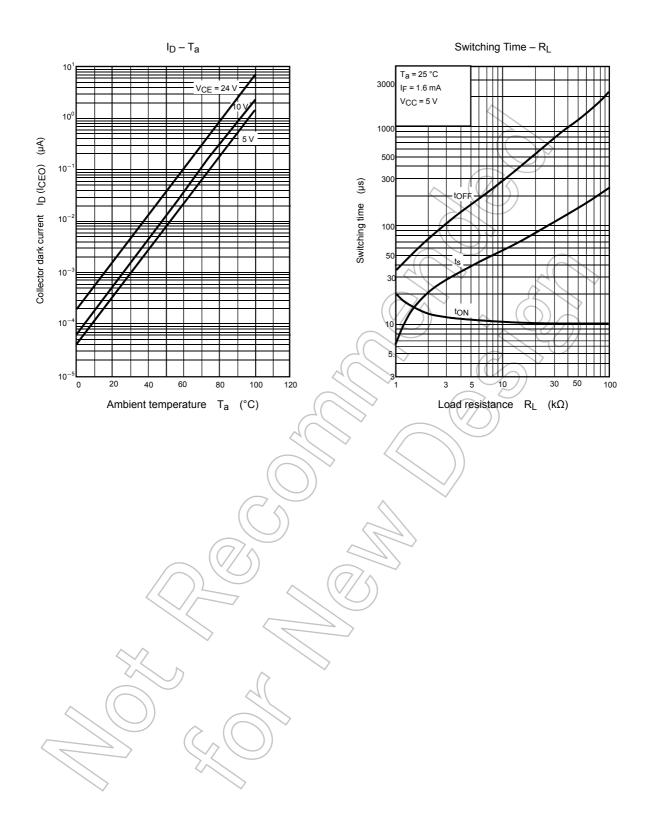
| Characteristic | Symbol | Test Condition | Min | Тур. | Max | Unit |
|----------------|------------------|--|------|------|-------------------|------|
| Rise time | t _r | | _ | 8 | | |
| Fall time | t _f | $V_{CC} = 10V, I_C = 2mA$ $R_L = 100\Omega$ | _ | 8 | 42 | |
| Turn-on time | t _{on} | | > _ | 10 | 7-// | μs |
| Turn-off time | t _{off} | | -0 | 8 | 7/m |) |
| Turn-on time | t _{ON} | | - | 10 | | |
| Storage time | t _s | $R_L = 4.7 k\Omega \text{ (Fig.1)}$ $V_{CC} = 5 \text{ V, I}_F = \pm 1.6 \text{mA}$ | -(() | 50 | ^{>} – | μs |
| Turn-off time | toff | | | 300 | _ | |

Fig. 1 Switching operating conditions









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